XN0A554 (XN6A554)

Silicon NPN epitaxial planar type

For high-speed switching

Features

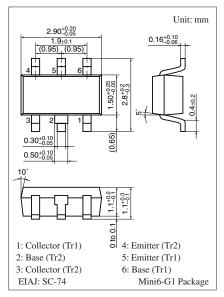
- Two elements incorporated into one package
- Reduction of the mounting area and assembly cost by one half
- \bullet Low collector-emitter saturation voltage $V_{\mbox{CE(sat)}}$

Basic Part Number

• 2SC3757 × 2

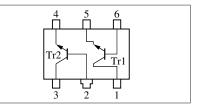
Absolute Maximum Ratings $T_a = 25^{\circ}C$

0 a								
Parameter	Symbol	Rating	Unit					
Collector-base voltage (Emitter open)	V _{CBO}	40	V					
Collector-emitter voltage (E-B short)	V _{CES}	40	V					
Emitter-base voltage (Collector open)	V _{EBO}	5	V					
Collector current	I _C	100	mA					
Peak collector current	I _{CP}	300	mA					
Total power dissipation	P _T	300	mW					
Junction temperature	Tj	150	°C					
Storage temperature	T _{stg}	-55 to +150	°C					



Marking Symbol: DT

Internal Connection



Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 40 V, I_E = 0$			0.1	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 4 V, I_C = 0$			0.1	μΑ
Forward current transfer ratio	h _{FE}	$V_{CE} = 1 \text{ V}, I_{C} = 10 \text{ mA}$	60		320	_
h _{FE} ratio *	h _{FE(Small}	$V_{CE} = 1 \text{ V}, I_{C} = 10 \text{ mA}$	0.50	0.99		_
	/Large)					
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{C} = 10 \text{ mA}, I_{B} = 1 \text{ mA}$		0.17	0.25	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{C} = 10 \text{ mA}, I_{B} = 1 \text{ mA}$			1.0	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$		450		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2	6	pF
(Common base, input open circuited)						
Turn-on time	t _{on}	Refer to the switching time measurement		17		ns
Turn-off time	t _{off}	circuit		17		ns
Storage time	t _{stg}			10		ns

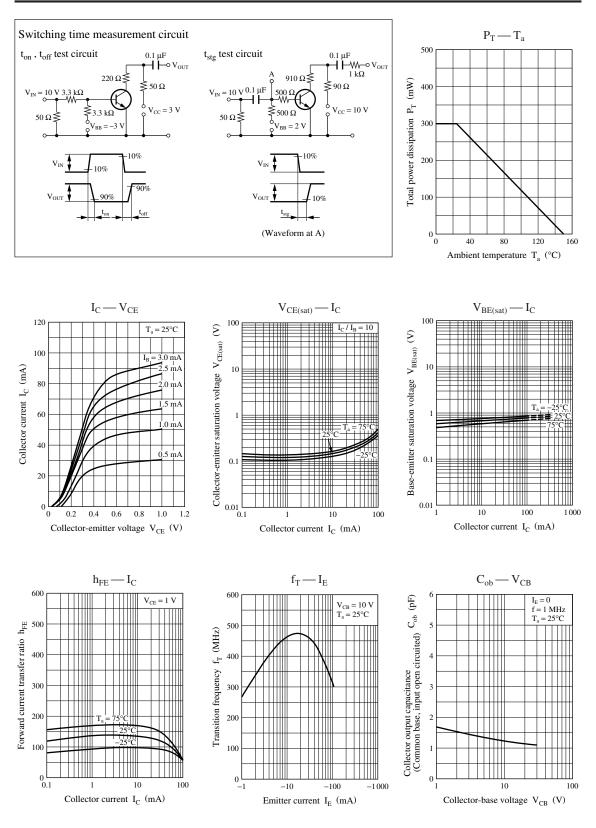
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Ratio between 2 elements

Note) The part number in the parenthesis shows conventional part number.

XN0A554

Panasonic



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